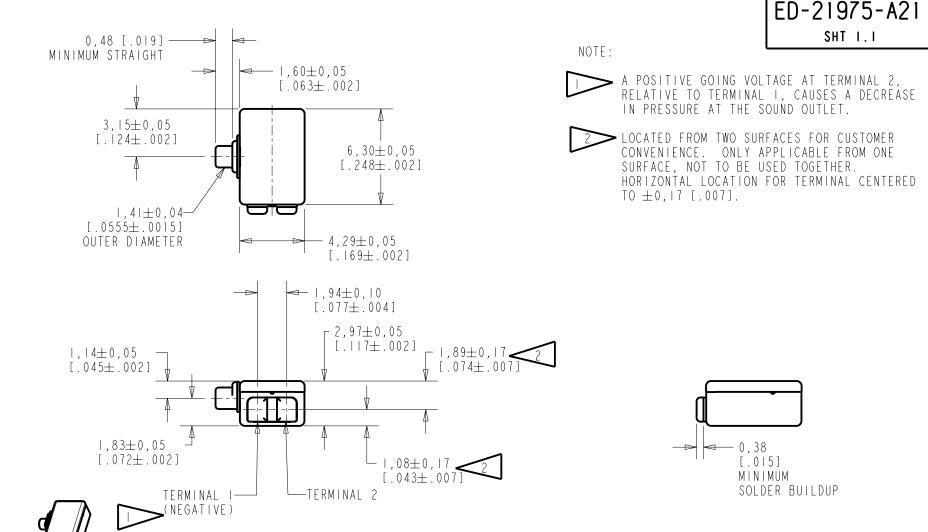
ED-21975-A21 SHT I.I - 0,38 [.015]MINIMUM SOLDER BUILDUP DELEACE LEVEL DEVISION

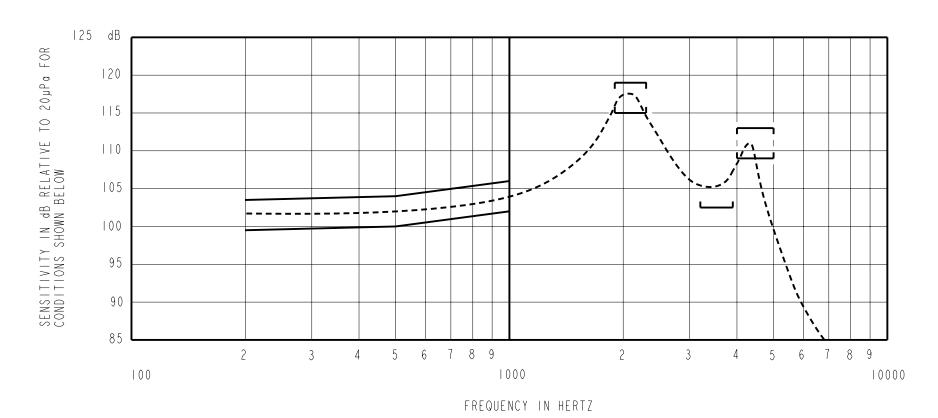


.31 GRAM DIMENSIONS IN MILLIMETERS [INCHES]

NOMINAL WEIGHT

KNOWLES ELECTRONICS ITASCA, ILLINOIS U.S.A.

ſ	Revision	C.O. #	Implementation Date	RELEASE LEVEL		REVISION
	A	C10105948	7 - 3 - 07	Released		A
Ī	SCALE:	SCALE: 4:1				DATE
İ		/ I NG	LSY ck. by	7 - 3 - 0 7 DATE		
ĺ	TITLE:	RECEIVER		ED-21975-A21	GJP APP. BY	7 - 9 - 0 7 DATE
		OUTL	INE DRAWING	SHT I.I	GJP	7-9-07



NOTES:

I. MEASUREMENTS MADE USING 10mm (.394") X 1mm (.039") ID TUBE CONNECTED TO A SIMULATED ANSI \$3.7-1973 TYPE HA-3 COUPLER. (IEC 126).

2.		SENSITIVITY	
	FREQUENCY	<u>MIN.</u>	MAX.
	200 500 1000 1900-2300 3200-3900 4000-5000	99.5 100.0 102.0 115.0 102.5 109.0	103.5 104.0 106.0 119.0

- 3. RESPONSE, IMPEDANCE, AND DISTORTION MEASUREMENTS MADE USING THE ELECTRICAL TEST CONDITIONS SHOWN BELOW.
- 4. ELECTRICAL SOURCE IMPEDANCE MUST BE GREATER THAN 20 TIMES IKHZ IMPEDANCE FOR TEST CONDITIONS SHOWN BELOW.
- 5. INDIVIDUAL SPECIFICATIONS.

PORT LOCATION	IMPEDANCE OHMS ±15%		DCR @20°C	DISTORTION		ELECTRICAL TEST CONDITIONS	
	IKHz	500Hz	OHMS 土I0%	MAX. %	FREQ Hz	AC mA RMS	DC mA
9C	1450	780	376	5	800	0.50	0.70

6.SUFFIX DESCRIPTIONS:

1) ADD SOLDER TO TERMINALS TO MEET A .015" MINIMUM HEIGHT SPEC.

2) APPLY ADDITIONAL CEMENT TO THE PERIMETER OF EH TERMINALS AT COVER WELD.

Revision	C.O. #	Implementation Date	RELEASE LEVEL		REVISION
			Released		Δ
Α	C10105948	7 - 3 - 0 7		/ \	
	WHEN TEST LIMITS ARE USED TO ESTABLISH INCOMING INSPECTION ACCEPTANCE/REJECTION				DATE
CRITERIA, CORRELATION OF TEST EQUIPMENT WITH KNOWLES IS ALSO REQUIRED FOR				100	7 - 3 - 0 7

7 - 3 - 07

DATE

7 - 9 - 07

7 - 9 - 07

KNOWLES ELECTRONICS ITASCA, ILLINOIS U.S.A.

ELIMINATI	ON OF EQUIPMENT AND TEST METHOD VARIAT	ION	LSY
			CK. BY
TITLE:	RECEIVER	ED-21975-A21	GJP
	MECETVEN	LD ZIOI O NZI	APP. BY
	PERFORMANCE SPECIFICATION	SHT 2.1	GJP